

# PSMN1R5-25YL

N-channel TrenchMOS logic level FET

Rev. 01 — 16 June 2009

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

Logic level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in industrial and communications applications.

#### 1.2 Features and benefits

- High efficiency due to low switching and conduction losses
- **1.3 Applications**

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- Class-D amplifiers
- DC-to-DC converters

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#### 1.4 Quick reference data

 Suitable for logic level gate drive sources

nexperia

- Motor control
- Server power supplies

Table 1.	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 150 °C		-	-	25	V
I <sub>D</sub>	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u> ;	[1]	-	-	100	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	-	109	W
Dynamic	characteristics						
Q <sub>GD</sub>	gate-drain charge	$\label{eq:VGS} \begin{array}{l} V_{GS} = 4.5 \text{ V}; \text{ I}_{D} = 10 \text{ A}; \\ V_{DS} = 12 \text{ V}; \text{ see } \underline{\text{Figure } 14}; \\ \text{see } \underline{\text{Figure } 15} \end{array}$		-	9.2	-	nC
Q <sub>G(tot)</sub>	total gate charge	$\label{eq:VGS} \begin{array}{l} V_{GS} = 4.5 \text{ V}; \text{ I}_{D} = 10 \text{ A}; \\ V_{DS} = 12 \text{ V}; \text{ see } \underline{\text{Figure } 14}; \\ \text{see } \underline{\text{Figure } 15} \end{array}$		-	36	-	nC
Static ch	aracteristics						
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; \text{ I}_{D} = 15 \text{ A};$ T <sub>j</sub> = 25 °C		-	1.13	1.5	mΩ
-							

[1] Continuous current is limited by package.

## 2. Pinning information

Table 2.	Pinning	information			
Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	S	source		_	
2	S	source	mb		
3	S	source			
4	G	gate	q;		
mb	D	mounting base; connected to drain	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	mbb076 S	
			SOT669 (LFPAK)		

## 3. Ordering information

Table 3.         Ordering information						
Type number						
	Name	Description	Version			
PSMN1R5-25YL	LFPAK	plastic single-ended surface-mounted package (LFPAK); 4 leads	SOT669			

## 4. Limiting values

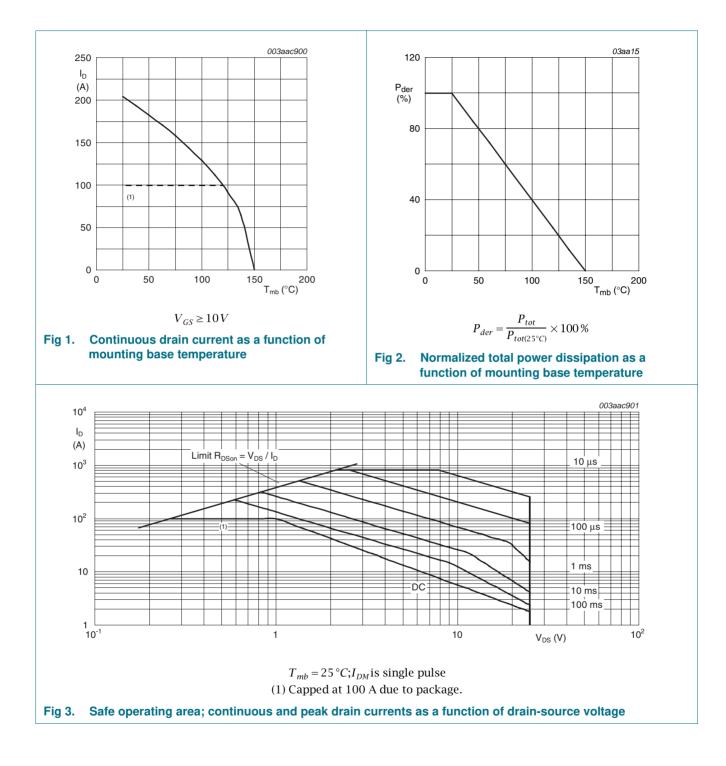
#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

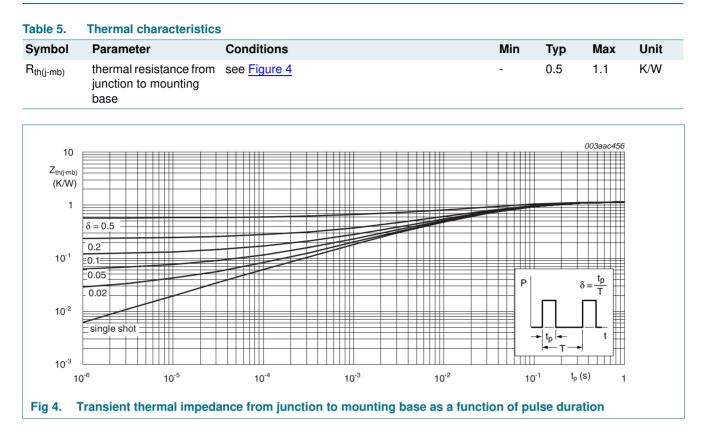
Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 150 °C		-	25	V
V <sub>DGR</sub>	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 150 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$		-	25	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
I <sub>D</sub>	drain current	$V_{GS}$ = 10 V; $T_{mb}$ = 100 °C; see <u>Figure 1</u>	[1]	-	100	А
		$V_{GS}$ = 10 V; $T_{mb}$ = 25 °C; see <u>Figure 1</u>	[1]	-	100	А
I <sub>DM</sub>	peak drain current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$ ; see Figure 3		-	815	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	109	W
T <sub>stg</sub>	storage temperature			-55	150	°C
Tj	junction temperature			-55	150	°C
Source-dr	ain diode					
ls	source current	T <sub>mb</sub> = 25 °C;	[1]	-	100	А
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	815	А
Avalanche	ruggedness					
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$V_{GS}$ = 10 V; $T_{j(init)}$ = 25 °C; $I_{D}$ = 100 A; $V_{sup}$ ≤ 25 V; $R_{GS}$ = 50 $\Omega;$ unclamped		-	290	mJ

[1] Continuous current is limited by package.

# PSMN1R5-25YL



### 5. Thermal characteristics

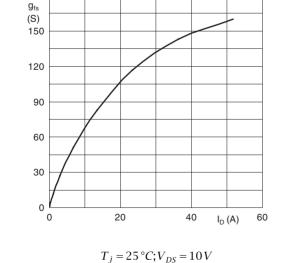


## 6. Characteristics

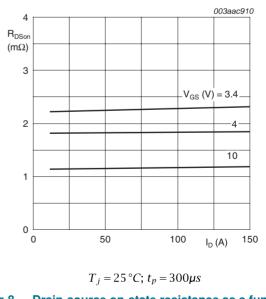
Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V <sub>(BR)DSS</sub>	drain-source	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	25	-	-	V
	breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = -55 \ ^\circ\text{C}$	22	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>	1.3	1.7	2.15	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 150 \text{ °C};$ see <u>Figure 12</u>	0.65	-	-	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = -55 °C; see <u>Figure 12</u>	-	-	2.45	V
I <sub>DSS</sub>	drain leakage current	$V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1	μA
		$V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	100	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS} = 16 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	100	nA
		$V_{GS}$ = -16 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
R <sub>DSon</sub>	drain-source on-state	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C	-	1.61	2.2	mΩ
	resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 150 °C; see <u>Figure 13</u>	-	-	2.6	mΩ
		$V_{GS}$ = 10 V; I <sub>D</sub> = 15 A; T <sub>j</sub> = 25 °C	-	1.13	1.5	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz	-	0.77	-	Ω
Dynamic	characteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 10 \text{ A}$ ; $V_{DS} = 12 \text{ V}$ ; $V_{GS} = 10 \text{ V}$ ; see <u>Figure 14</u> ; see <u>Figure 15</u>	-	76	-	nC
		$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$	-	71	-	nC
		$I_D$ = 10 A; $V_{DS}$ = 12 V; $V_{GS}$ = 4.5 V; see <u>Figure 14</u> ; see <u>Figure 15</u>	-	36	-	nC
Q <sub>GS</sub>	gate-source charge	$I_D = 10 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$	-	12.3	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate-source charge	see <u>Figure 14;</u> see <u>Figure 15</u>	-	7.8	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate-source charge		-	4.5	-	nC
Q <sub>GD</sub>	gate-drain charge		-	9.2	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	V <sub>DS</sub> = 12 V; see <u>Figure 14</u>	-	2.4	-	V
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 12 V; V <sub>GS</sub> = 0 V; f = 1 MHz;	-	4830	-	pF
C <sub>oss</sub>	output capacitance	$T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{100}$	-	1280	-	рF
C <sub>rss</sub>	reverse transfer capacitance		-	465	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 12 V; $R_L$ = 0.5 Ω; $V_{GS}$ = 4.5 V;	-	50	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 4.7 \ \Omega$	-	97	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	72	-	ns
t <sub>f</sub>	fall time		-	36	-	ns

## PSMN1R5-25YL

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ource-dr	rain diode						
SD	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; \text{ T}_j$ see <u>Figure 17</u>	= 25 °C;	-	0.78	1.2	V
r	reverse recovery time	$I_{\rm S} = 20 \text{ A}; \text{ d}I_{\rm S}/\text{d}t = -100 \text{ J}$	A/μs; V <sub>GS</sub> = 0 V;	-	43	-	ns
łr	recovered charge	$V_{DS} = 20 V$		-	50	-	nC
	[1] Tested	to JEDEC standards where a	pplicable.				
80 I <sub>D</sub>		003aac903	180 I <sub>D</sub> (A)			003aac902	
(A) 60			150 3.6 150 73.4 120	2		3-	
40			90			2.8	
20	T <sub>j</sub> = 150 °C	25 °C	30		V <sub>GS</sub> (V	2.6	
0			0	2 4			,
(	0 1 2	<sup>3</sup> <sub>VGS</sub> (V) <sup>4</sup>	0	2 4	0	8 V <sub>DS</sub> (V)	)
	$V_{DS} = 10 V$			$T_j = 25 ^{\circ}C; t_j$	, = 300µs		
	Fransfer characteristics: unction of gate-source			characteristic n of drain-sou			
180		003aac909	4			003aac910	1
g <sub>fs</sub> (S)			R <sub>DSon</sub>				
150			(mΩ)				

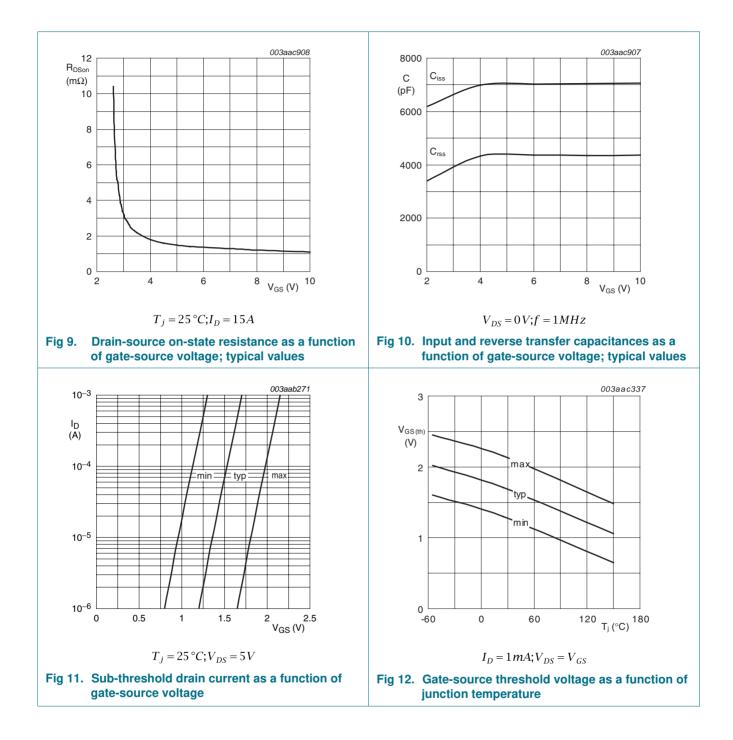




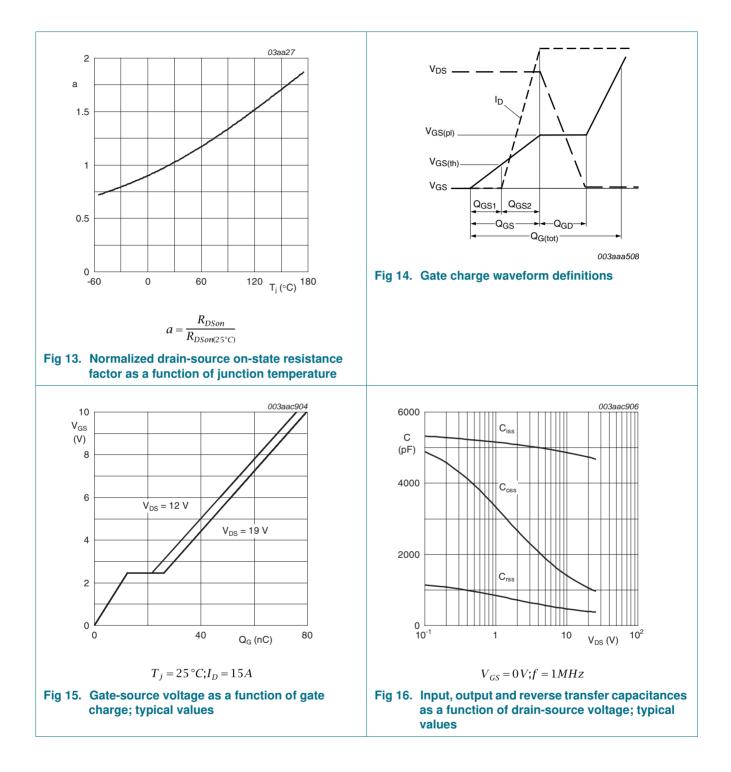




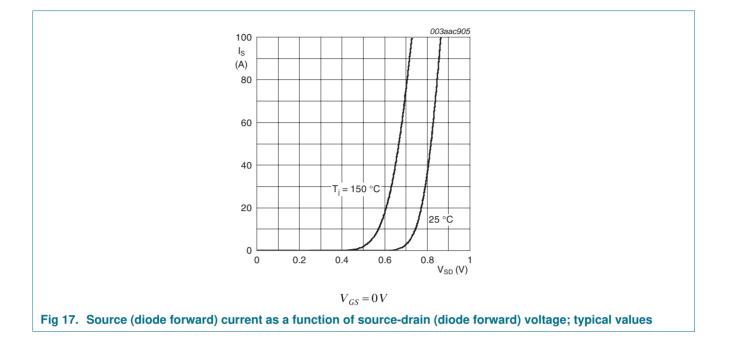
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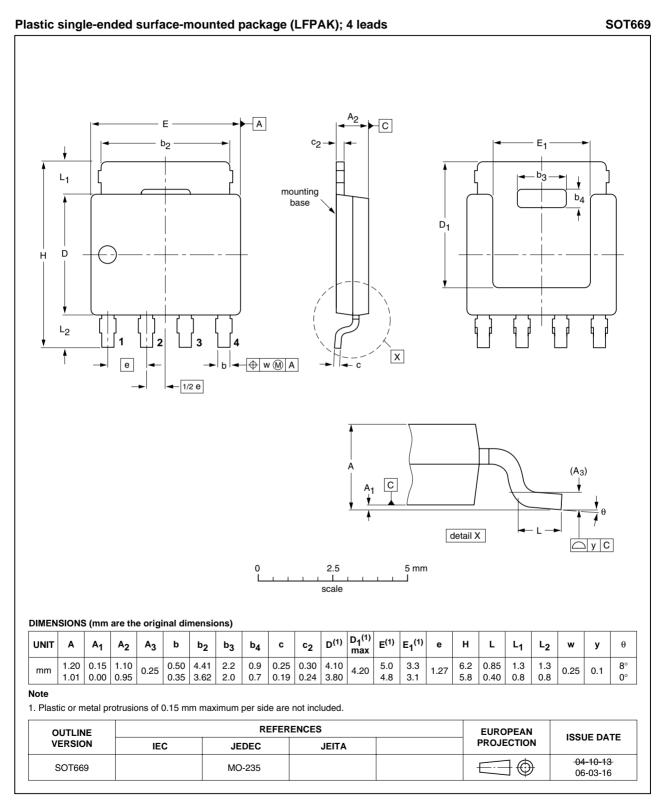
## PSMN1R5-25YL



# PSMN1R5-25YL



## 7. Package outline



#### Fig 18. Package outline SOT669 (LFPAK)

PSMN1R5-25YL\_1

## 8. Revision history

Table 7. Revision hist	Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PSMN1R5-25YL_1	20090616	Product data sheet	-	-		

## 9. Legal information

#### 9.1 Data sheet status

Document status [1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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#### N-channel TrenchMOS logic level FET

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